Vishay Siliconix

RoHS

COMPLIANT HALOGEN

FREE

N- and P-Channel 20 V (D-S) MOSFET

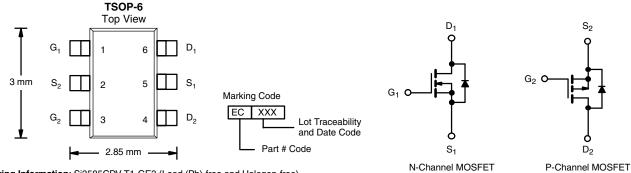
PRODUCT SUMMARY							
	V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A) ^a	Q _g (Typ.)			
N-Channel	nel 20	0.058 at V_{GS} = 4.5 V	3.9	2.9 nC			
N-Channel		0.078 at V_{GS} = 2.5 V	3.3	2.9110			
P-Channel	nannel - 20	0.195 at V_{GS} = - 4.5 V	- 2.1	1.6 nC			
		0.316 at V_{GS} = - 2.5 V	- 1.7	1.0110			

FEATURES

- TrenchFET[®] Power MOSFETs
- 100 % R_g Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Load Switch for Portable Devices
- **DC/DC** Converters
- Drivers: Motor, Solenoid, Relay



Ordering Information: Si3585CDV-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)							
Parameter	Symbol	N-Channel	P-Channel	Unit			
Drain-Source Voltage	V _{DS}	20	- 20	V			
Gate-Source Voltage	V _{GS}	±	v				
	T _C = 25 °C		3.9	- 2.1			
Continuous Drain Current (T 150 °C)	T _C = 70 °C		3.1	- 1.7			
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	- I _D -	3.5 ^{b, c}	- 1.9 ^{b, c}			
	T _A = 70 °C		2.8 ^{b, c}	- 1.5 ^{b, c}	А		
Pulsed Drain Current (t = 300 µs)		I _{DM}	12	- 5			
Courses Duraine Oursent Diada Oursent	T _C = 25 °C	- I _S	1.2	- 1.1			
Source Drain Current Diode Current	T _A = 25 °C		0.9 ^{b, c}	- 0.9 ^{b, c}			
	T _C = 25 °C		1.4	1.3			
Marian Brance Disciplination	T _C = 70 °C	Б	0.9	0.8			
Maximum Power Dissipation	T _A = 25 °C	PD	1.1 ^{b, c}	1.1 ^{b, c}	W		
	T _A = 70 °C		0.7 ^{b, c}	0.7 ^{b, c}			
Operating Junction and Storage Temperature Ra	Operating Junction and Storage Temperature Range			o 150	°C		

THERMAL RESISTANCE RATINGS											
Parameter	Symbol	N-Ch	annel	P-Channel		Unit					
	Symbol	Тур.	Max.	Тур.	Max.	Onit					
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	93	110	97	115	°C/W				
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	75	90	78	95	- °C/W				

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 150 °C/W for n-channel and 155 °C/W for p-channel.

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Parameter Symbol Test Conditions				Min.	Тур.	Max.	Unit	
Static				1		1		
	N/	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	N-Ch	20				
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I _D = - 250 µA	P-Ch	- 20			V	
	м (т	I _D = 250 μA	N-Ch		15			
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA	P-Ch		- 16.2			
	A)/ /T	I _D = 250 μA	N-Ch		- 2.8		mV/°	
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA	P-Ch		2.5			
Octo Thursehold Make as	V	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	N-Ch	0.6		1.5	v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	P-Ch	- 0.6		- 1.5	V	
Gate-Source Leakage	lass	$V_{DS} = 0 V, V_{GS} = \pm 12 V$	N-Ch			± 100	nA	
Gale-Source Leakage	I _{GSS}		P-Ch			± 100		
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch			1		
Zero Gate Voltage Drain Current	Inco	$V_{DS} = -20 V, V_{GS} = 0 V$	P-Ch			- 1		
	IDSS	V_{DS} = 20 V, V_{GS} = 0 V, T_{J} = 55 °C	N-Ch			10	μA	
		V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 55 °C	P-Ch			- 10		
		$V_{DS} \ge 5$ V, $V_{GS} = 4.5$ V	N-Ch	12			A	
On-State Drain Current ^D	I _{D(on)}	$V_{DS} \leq$ - 5 V, V_{GS} = - 4.5 V	P-Ch	- 5				
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	N-Ch		0.048	0.058		
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 1.9 A	P-Ch		0.162	0.195	Ω	
		V _{GS} = 2.5 V, I _D = 1 A	N-Ch		0.065	0.078		
		V _{GS} = - 2.5 V, I _D = - 1 A	P-Ch		0.263	0.316		
– .– b		V _{DS} = 10 V, I _D = 35 A	N-Ch		12		<u> </u>	
Forward Transconductance ^D	9 _{fs}	V _{DS} = - 10 V, I _D = - 1.9 A P-Ch			1		S	
Dynamic ^a								
Input Consolitones	C _{iss}		N-Ch		150			
Input Capacitance	Oiss	N-Channel V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	P-Ch		210			
Output Capacitance	C _{oss}	$v_{\rm DS} = 10^{-1}$, $v_{\rm GS} = 0^{-1}$, $1 = 1^{-1}$ with 2	N-Ch		53		pF	
	- 033	P-Channel	P-Ch N-Ch		50			
Reverse Transfer Capacitance	C _{rss}	V_{DS} = - 10 V, V_{GS} = 0 V, f = 1 MHz			22		_	
· · · · · · · · · · · · · · · · · · ·			P-Ch		35	1.0		
		$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.5 \text{ A}$	N-Ch		3.2	4.8	_	
Total Gate Charge	Qg	V_{DS} = - 10 V, V_{GS} = - 10 V, I_D = - 1.9 A	P-Ch		6	9		
	-	N-Channel	N-Ch		1.6	2.4	-	
		$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 3.5 \text{ A}$	P-Ch		2.9	4.3	nC	
Gate-Source Charge	Q _{gs}		N-Ch		0.3		-	
	-	P-Channel	P-Ch N-Ch		0.6		-	
Gate-Drain Charge	Q _{gd}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -1.9 \text{ A}$			0.4 0.9			
			P-Ch N-Ch	0.9	4.8	9.6		
Gate Resistance	Rg	f = 1 MHz	P-Ch	1.2	4.0 6.2	9.0 12.4	Ω	
				1.2	0.2	12.4	ł	



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Parameter	Symbol	Test Conditions			Тур.	Max.	Unit		
Dynamic ^a									
Turn-On Delay Time	t _{d(on)} N-Channel		N-Ch		5	10			
	u(on)	$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 3.6 \Omega$	P-Ch		3	6			
Rise Time	t _r	$I_D \cong 2.8 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	N-Ch		20	30			
		- Č	P-Ch N-Ch		10 11	20 20			
Turn-Off Delay Time	t _{d(off)}	P-Channel	P-Ch		13	20			
		$V_{DD} = -10 \text{ V}, \text{R}_{\text{L}} = 6.7 \Omega$ $\text{I}_{\text{D}} \cong -1.5 \text{A}, \text{V}_{\text{GEN}} = -10 \text{V}, \text{R}_{\text{a}} = 1 \Omega$	N-Ch		8	16			
Fall Time	t _f	$B = 1.5 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, H_{\text{g}} = 1.22$	P-Ch		7	14	- ns 		
			N-Ch		15	23			
Turn-On Delay Time	t _{d(on)}	N-Channel	P-Ch		16	25			
Rise Time	t _r	$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 3.6 \Omega$	N-Ch		37	56			
nise lille		$\text{I}_\text{D}\cong$ 2.8 A, V_GEN = 4.5 V, R_g = 1 Ω	P-Ch		16	25			
Turn-Off Delay Time	t _{d(off)}	P-Channel V_{DD} = - 10 V, R _L = 6.7 Ω	N-Ch		25	38			
	-u(011)		P-Ch		13	20			
Fall Time	t _f	$\rm I_D \cong$ - 1.5 A, $\rm V_{GEN}$ = - 4.5 V, $\rm R_g$ = 1 Ω	N-Ch		28	42			
During Courses Dardy Diada Obayastavisti			P-Ch		9	18			
Drain-Source Body Diode Characteristi	cs		N-Ch	1	1	1.2			
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C	P-Ch			- 1.1			
			N-Ch			12	Α		
Pulse Diode Forward Current ^a	I _{SM}		P-Ch			- 5			
		I _S = 2.8 A, V _{GS} = 0 V	N-Ch		0.8	1.2	v		
Body Diode Voltage	V _{SD}	I _S = - 1.5 A, V _{GS} = 0 V	P-Ch		- 0.8	- 1.2			
	t _{rr}		N-Ch		8	16			
Body Diode Reverse Recovery Time			P-Ch		21	32	ns		
Pady Diada Payaraa Pagayany Charge	0		N-Ch		2	4	20		
Body Diode Reverse Recovery Charge	Q _{rr}	$I_F = 2.8 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{T}_J = 25 ^\circ\text{C}$	P-Ch		11	20	nC		
Reverse Recovery Fall Time	t _a	P-Channel	N-Ch		5				
	°a	$I_F = -1.5 \text{ A}, \text{ dI/dt} = -100 \text{ A/}\mu\text{s}, \text{T}_J = 25 ^{\circ}\text{C}$	P-Ch		10		ns		
Reverse Recovery Rise Time	t _b		N-Ch		3		115		
	-u		P-Ch		11				

Notes:

a. Guaranteed by design, not subject to production testing.

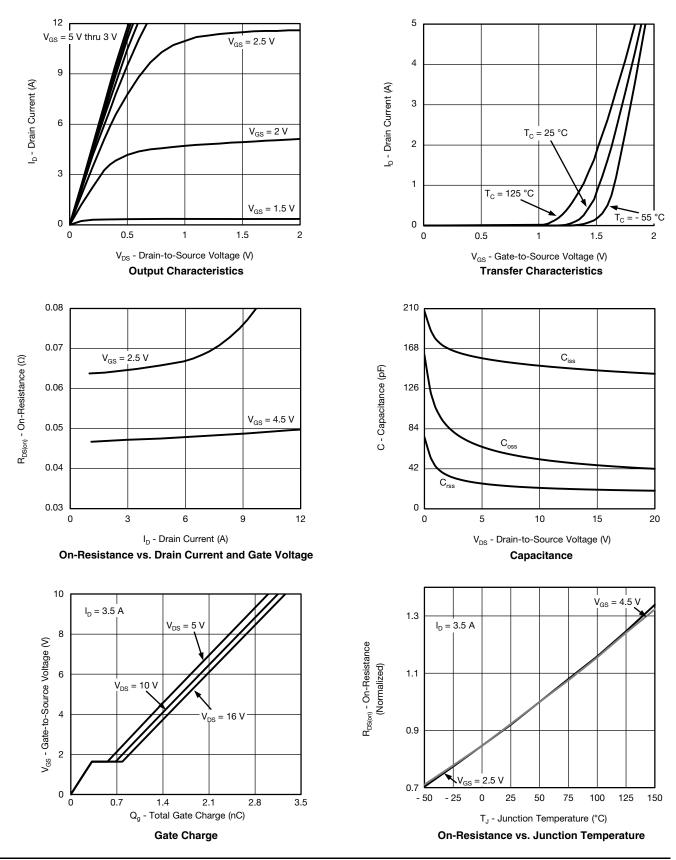
b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



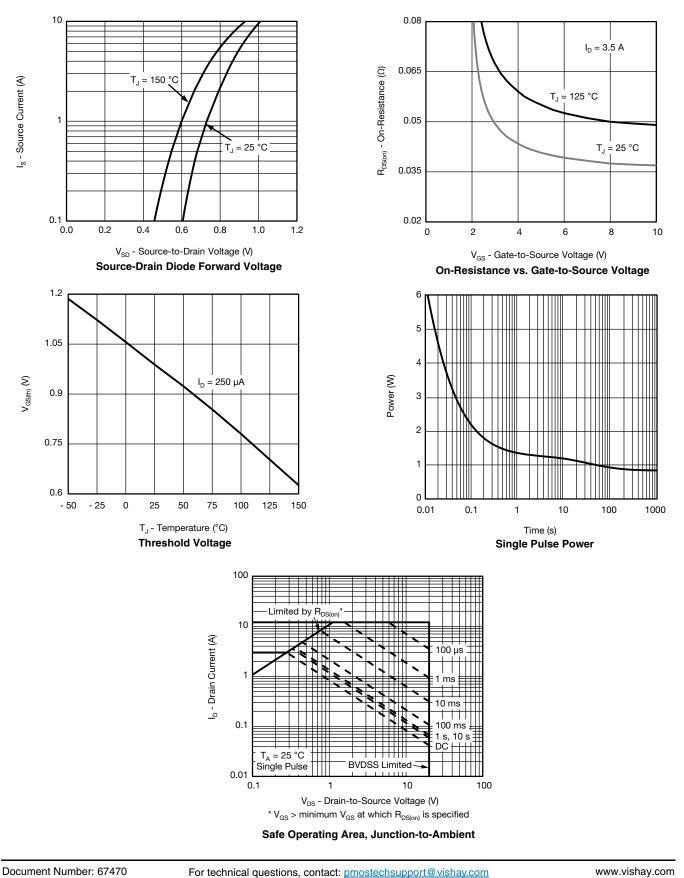
For technical questions, contact: pmostechsupport@vishay.com

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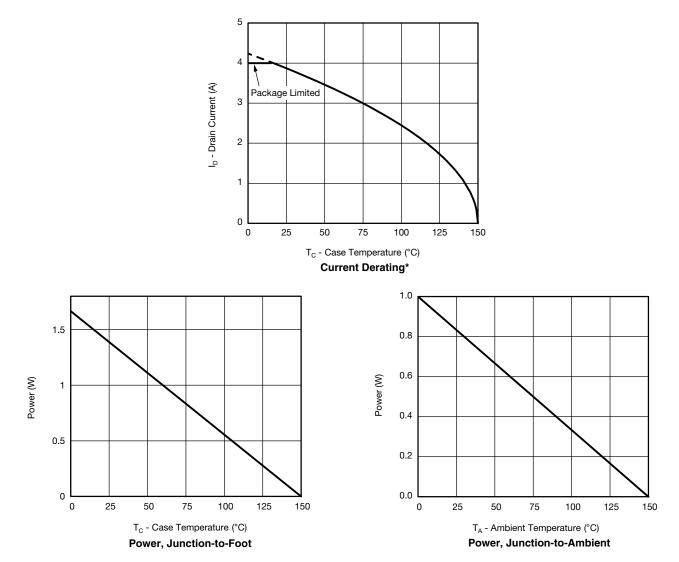
Si3585CDV Vishay Siliconix

N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

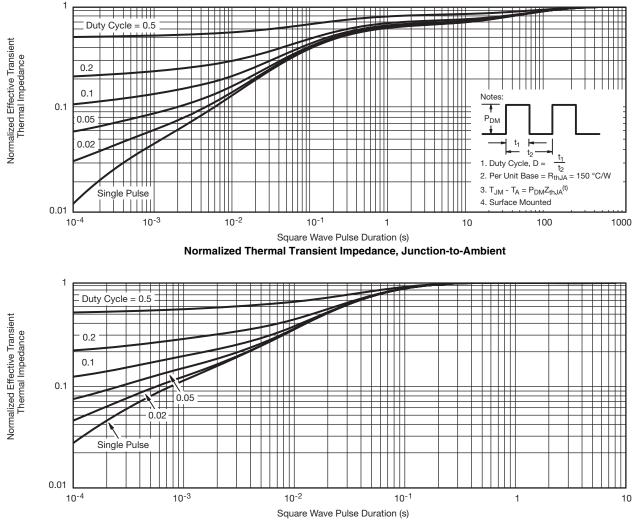
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Si3585CDV Vishay Siliconix

N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

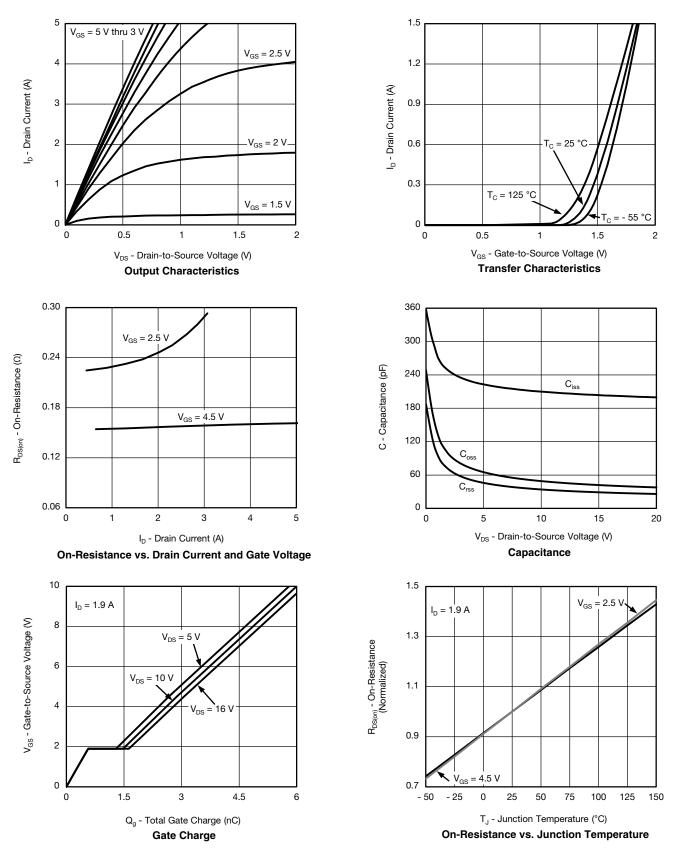


Normalized Thermal Transient Impedance, Junction-to-Foot



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P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



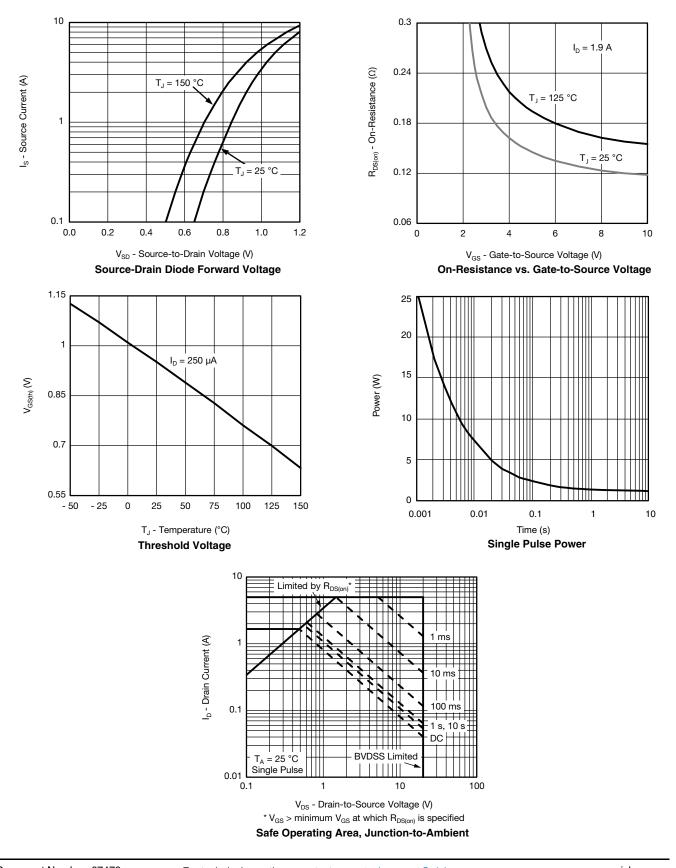
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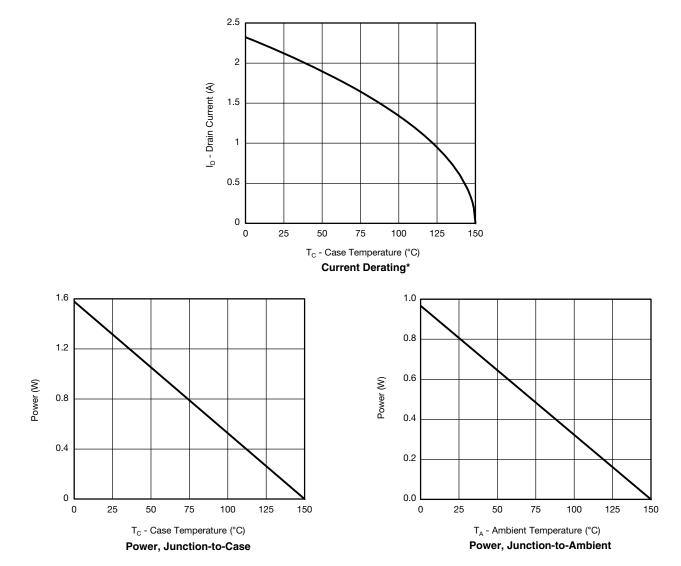
Si3585CDV Vishay Siliconix

P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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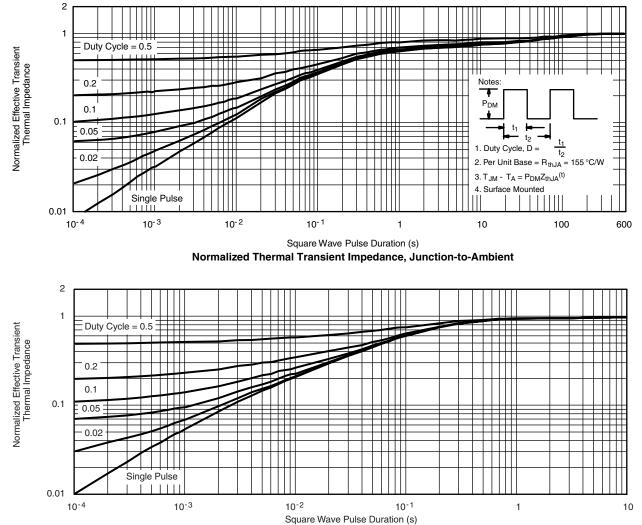
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Foot

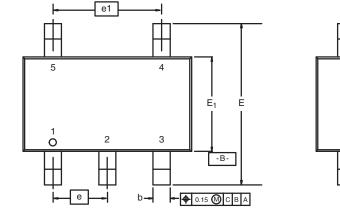
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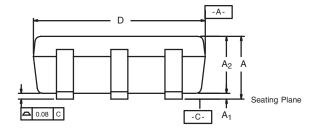
Package Information

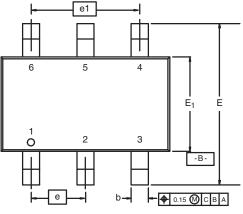
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TSOP: 5/6-LEAD JEDEC Part Number: MO-193C

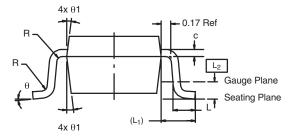








6-LEAD TSOP



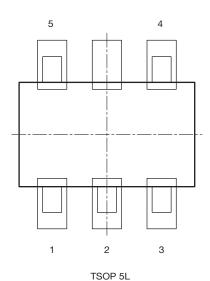
	MIL	LIMETER	RS	I	NCHES		
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
E	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC		0.0374 BSC			
e ₁	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁		0.60 Ref			0.024 Ref	-	
L ₂		0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ1	7° Nom 7° Nom						
ECN: C DWG: 5		ev. I, 18-Dec	-06				

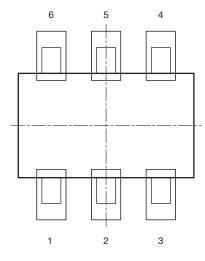
PAD Pattern



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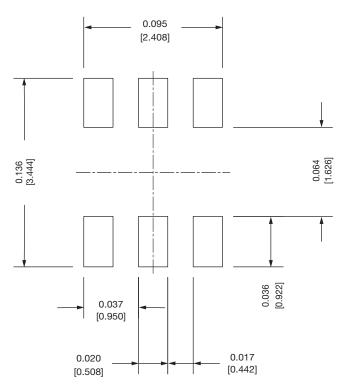
Recommended Land Pattern For TSOP-5L / TSOP-6L











Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev.	B, 24-Oct-2022		
DWG: 3010			

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